

# FAN1080M6X

## Offline Primary-Side-Regulation (PSR) Quasi-Resonant Valley Switch Controller

FAN1080 is offline Primary-Side-Regulation (PSR) PWM controller with Quasi-Resonant (QR) mode controller to achieved constant-voltage (CV) and constant-current (CC) control for Travel Adaptor (TA) requirement and provide cost-effective, simplified circuit for energy-efficient power supplies.

FAN1080 is designed to have good energy efficiency technology that offers options to users to meet different power consumption targets using different startup components.

FAN1080 can be used in Travel Adapter design by stand-alone or co-work with secondary-side SR controller FAN6250/FAN6251. While pairing with FAN6292C, FAN1080 can be used to design a high density Type-C travel adapter in compact system BOM.

### Features

- Ultra-Low Standby Power Consumption Feasible: < 30 mW through HV FET and < 75 mW through HV Resistor
- Constant-Current (CC) and Constant-Voltage(CV) with Primary – Side Regulation Eliminates Secondary-Side Feedback Component
- Valley Switch Operation for Highest Average Efficiency
- Dynamic Response Enhancement (DRE) Function for Excellent Dynamic Response without the Need of OPTO
- Low EMI Emissions and Common Mode Noise
- Programmable Brown-In and Brown-Out Protection
- Output Over-Voltage Protection (OVP)
- Output Under-Voltage Protection (UVP)
- Secondary Side Rectifier Short Detection via Current Sense Protection(CSP)
- Cycle-by-Cycle Current Limiting
- These Devices are Pb-Free, Halogen Free and are RoHS Compliant

### Typical Applications

- Travel Adapter for Smart Phones, Feature Phones, and Tablet PCs
- AC-DC Adapters for Portable Devices or Battery Chargers that Require CV/CC Control



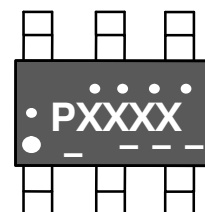
ON Semiconductor®

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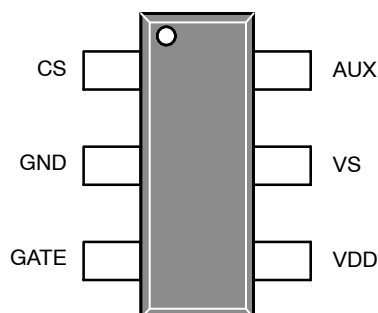
SOT23  
CASE 527AJ

### MARKING DIAGRAM



....	= Year Code
PXX	= 080: FAN1080M6X
XX	= Die Run Code
---	= Week Code

### PIN CONNECTIONS



### ORDERING INFORMATION

See detailed ordering and shipping information on page 17 of this data sheet.

# FAN1080M6X

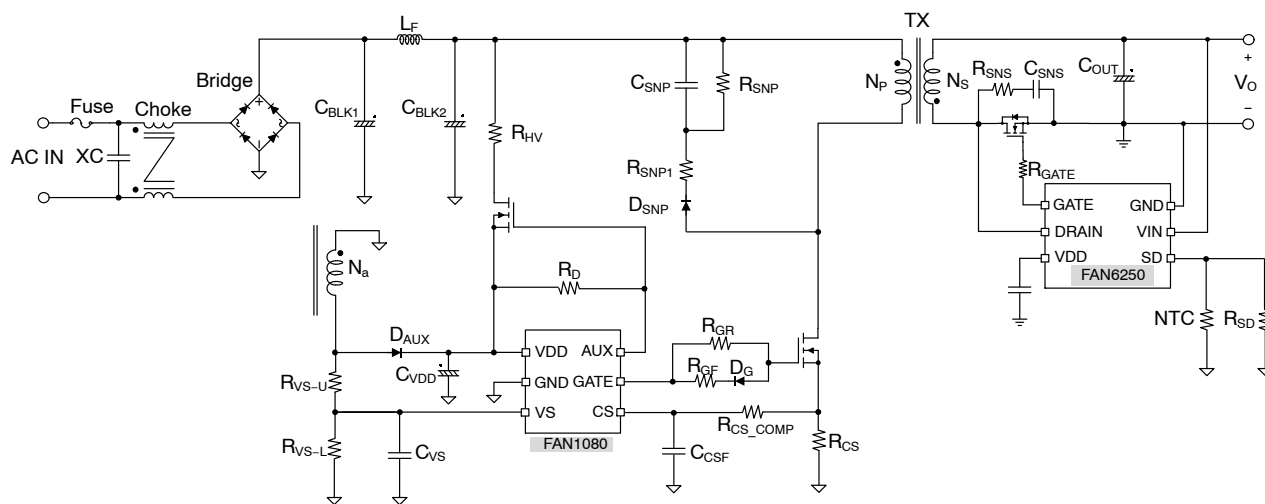


Figure 1. FAN1080 Typical Application Schematic

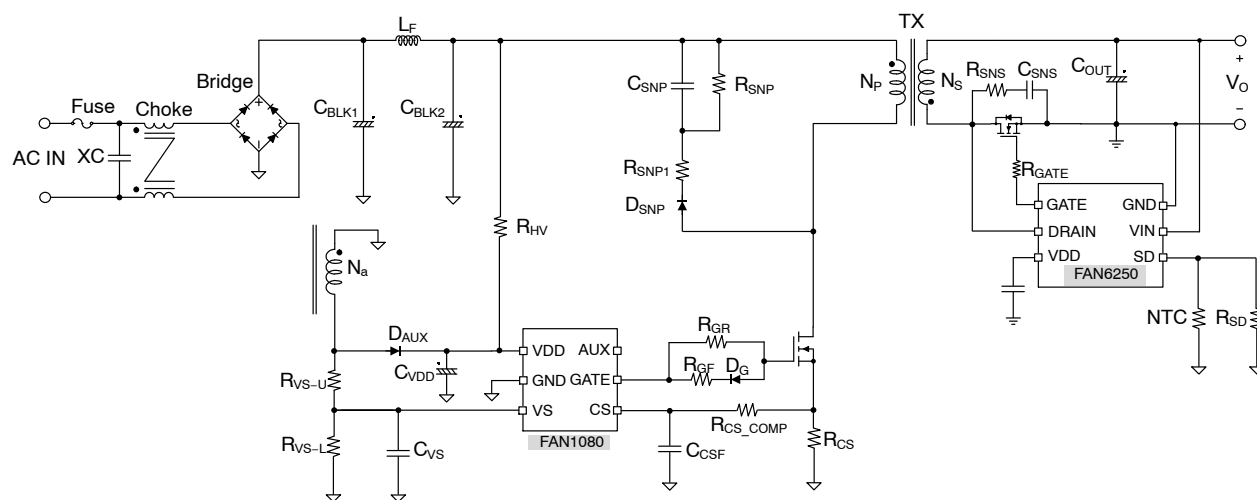


Figure 2. FAN1080 Typical Application Schematic

# FAN1080M6X

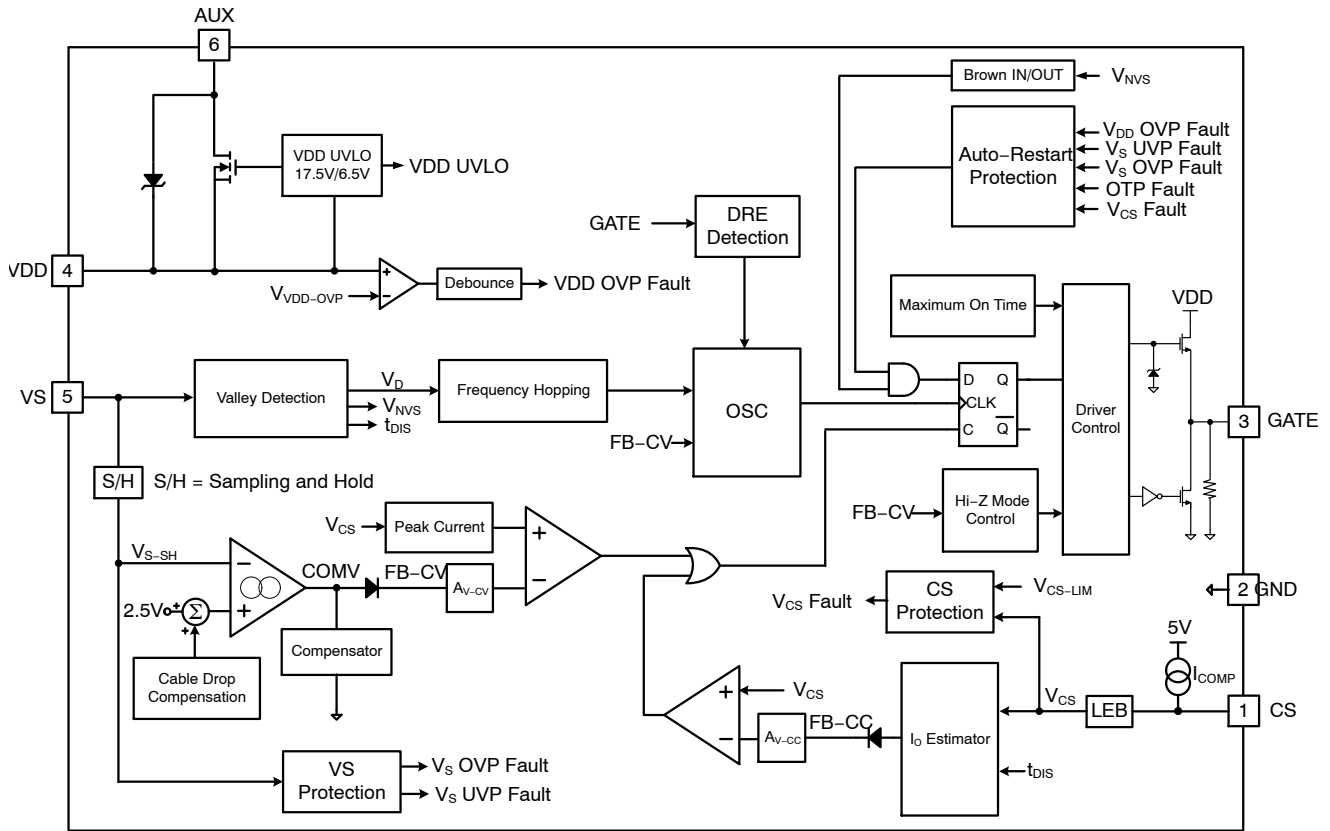


Figure 3. FAN1080 Block Diagram

## PIN FUNCTION DESCRIPTION

Pin No.	Name	Description
1	CS	<b>Current Sense.</b> This pin connects to a current-sense resistor to detect the MOSFET current for Peak-Current-Mode control for output regulation. The current-sense information is also used to estimate the output current for CC regulation
2	GND	<b>Ground.</b>
3	GATE	<b>PWM Signal Output.</b> This pin has an internal totem-pole output driver to drive the power MOSFET. The gate driving voltage is internally clamped at 7.5 V
4	VDD	<b>Power Supply.</b> IC operating current and MOSFET driving current are supplied through this pin. This pin is typically connected to an external VDD capacitor
5	VS	<b>Voltage Sense.</b> The VS voltage is used to detect resonant valleys for quasi-resonant switching. This pin detects the output voltage information and diode current discharge time based on the auxiliary winding voltage. It also senses input voltage for Brown-IN/OUT protection
6	AUX	<b>Auxiliary Function.</b> The pin is used for startup with external depletion HV FET

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## MAXIMUM RATINGS

Parameter		Symbol	Value	Unit
DC Supply Voltage		$V_{DD}$	30	V
Maximum Voltage on GATE Pin		$V_{GETE}$	−0.3 to 30	V
Maximum Voltage on Low Power Pins (Except Pin 3, Pin 4, Pin 6)		$V_{max}$	−0.3 to 6	V
Power Dissipation ( $T_A = 25^{\circ}\text{C}$ )		$P_D$	467.4	mW
Thermal Resistance (Junction-to-Ambient)		$\theta_{JA}$	218.5	C/W
Thermal Resistance (Junction-to-Top)		$\theta_{JT}$	33.1	$^{\circ}\text{C/W}$
Operating Junction Temperature		$T_J$	−40 to +150	$^{\circ}\text{C}$
Storage Temperature Range		$T_{STG}$	−40 to +150	$^{\circ}\text{C}$
Electrostatic Discharge Capability	Human Body Model, JEDEC:JESD22_A114	ESD	1.5	kV
	Charged Device Model, JEDEC:JESD22_C101		0.5	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. All voltage values, except differential voltages, are given with respect to GND pin.
2. Stresses beyond those listed under Maximum Ratings may cause permanent damage to the device.
3. Meets JEDEC standards JS-001-2012 and JESD 22-C101.

## RECOMMENDED OPERATING RANGES

Parameter	Symbol	Min	Max	Unit
VDD Pin Supply Voltage	$V_{DD}$	6	25	V
VS Pin Supply Voltage	$V_{VS}$	0.65	3.0	V
CS Pin Supply Voltage	$V_{CS}$	0	0.8	V
AUX Pin Supply Voltage	$V_{AUX}$	0	$V_{DD} - 5V$	V
Operating Temperature	$T_A$	−40	+85	$^{\circ}\text{C}$

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

4. The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance. ON Semiconductor does not recommend exceeding them or designing to Maximum Ratings.

## ELECTRICAL CHARACTERISTICS

For typical values  $T_J = 25^{\circ}\text{C}$ , for min/max values  $T_J = -40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ ,  $V_{DD} = 12\text{ V}$ ; unless otherwise noted.

Parameter	Test Conditions	Symbol	Min	Typ	Max	Unit
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### VDD SECTION

Turn-On Threshold Voltage	$V_{DD}$ Rising	$V_{DD-ON}$	16.5	17.5	18.5	V
Turn-Off Threshold Voltage	$V_{DD}$ Falling	$V_{DD-OFF}$	6.1	6.5	6.9	V
Startup Current	$V_{DD} = V_{DD-ON} - 0.16\text{ V}$	$I_{DD-ST}$	–		20	$\mu\text{A}$
Operating Supply Current		$I_{DD-OP}$	–	1.2		mA
Deep Green-Mode Operating Supply Current		$I_{DD-DPGN}$	–	–	460	$\mu\text{A}$
$V_{DD}$ Over-Voltage-Protection Level		$V_{VDD-OVP}$	26.5	28.0	29.5	V
$V_{DD}$ Over-Voltage-Protection Debounce Time		$t_{D-VDDOVP}$	–	120	200	$\mu\text{s}$

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## ELECTRICAL CHARACTERISTICS (continued)

For typical values  $T_J = 25^\circ\text{C}$ , for min/max values  $T_J = -40^\circ\text{C}$  to  $125^\circ\text{C}$ ,  $V_{DD} = 12\text{ V}$ ; unless otherwise noted.

Parameter	Test Conditions	Symbol	Min	Typ	Max	Unit
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### OSCILLATOR SECTION

Maximum Blanking Frequency		$f_{\text{BNK-MAX}}$	70	77	83	kHz
Minimum Blanking Frequency		$f_{\text{BNK-MIN}}$	24	27	30	kHz
Maximum DCM Operation Frequency		$f_{\text{OSC-DCM-MAX}}$	22	25	28	kHz
Minimum DCM Operation Frequency		$f_{\text{OSC-DCM-MIN}}$	0.080	0.105	0.130	kHz
Minimum Frequency for CCM Prevention		$f_{\text{OSC-CCM}}$	18	21	24	kHz
Frequency Hopping Range		$\Delta f_{\text{Hopping}}$	3	4	5	kHz
Frequency Hopping Period		$\Delta t_{\text{Hopping}}$	1.8	2.5	3.2	ms

### AUX SECTION

Clamping Voltage between VDD and AUX pin	$V_{DD} = V_{DD-ON}$	$\Delta V_{\text{CLAMP}}$	–	5	–	V
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### CURRENT-SENSE SECTION

Current Limit Threshold Voltage		$V_{\text{CS-LIM}}$	0.67	0.70	0.73	V
High Threshold Voltage of Current Sense		$V_{\text{CS-IMIN}}$	0.200	0.225	0.250	V
GATE Output Turn-Off Delay (Note 5)		$t_{\text{PD}}$	–	100	–	ns
Leading-Edge Blanking Time		$t_{\text{LEB}}$	290	345	400	ns

### CONSTANT CURRENT ESTIMATOR SECTION

Reference Voltage of Constant Current		$V_{\text{VR-CC}}$	1.19	1.2	1.21	V
Peak Value Amplifying Gain (Note 5)		$A_{\text{PK}}$		3.6		V/V

### CONSTANT CURRENT CORRECTION SECTION

High Line Compensation Current	$V_{\text{IN}} = 264\text{ V}_{\text{rms}}$	$I_{\text{COMP-H}}$	71	75	79	$\mu\text{A}$
Low Line Compensation Current	$V_{\text{IN}} = 90\text{ V}_{\text{rms}}$	$I_{\text{COMP-L}}$	23.5	25.5	27.5	$\mu\text{A}$
Internal Line Voltage Compensation Resistance (Note 5)		$R_{\text{COMP-LINE}}$		575		$\Omega$

### CABLE DROP COMPENSATION SECTION

Cable Drop Compensation Voltage		$\Delta V_{\text{CDC}}$	135	145	155	mV
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### OVER-TEMPERATURE PROTECTION SECTION

Threshold Temperature for Over-Temperature-Protection (Note 5)		$T_{\text{OTP-H}}$	–	130	–	$^\circ\text{C}$
Threshold Temperature for Over-Temperature-Protection (Note 5)		$T_{\text{OTP-L}}$	–	110	–	$^\circ\text{C}$

### VOLTAGE-SENSE SECTION

Reference Voltage of Constant Voltage		$V_{\text{VR-CV}}$	2.475	2.500	2.525	V
VS Sampling Blanking Time L	$T_J = 25^\circ\text{C}$	$t_{\text{VS-BNK-L}}$	1.8	1.9	2.0	$\mu\text{s}$
VS Sampling Blanking Time H	$T_J = 25^\circ\text{C}$	$t_{\text{VS-BNK-H}}$	2.2	2.3	2.4	$\mu\text{s}$
VS Source Current Threshold to Enable Brown-OUT	Set $V_{\text{IN}} = 264\text{ VAC}$ (373 VDC) $N_P:N_S:N_A = 54:8:4$ , $R_{\text{VS-U}} = 27.4\text{ k}\Omega$	$I_{\text{VS-Brown-OUT}}$	270	320	370	$\mu\text{A}$
Brown-OUT Debounce Time		$t_{\text{D-Brown-OUT}}$	12	17	22	ms
VS Source Current Threshold to Enable Brown-IN	Set $V_{\text{IN}} = 264\text{ VAC}$ (373 VDC) $N_P:N_S:N_A = 54:8:4$ , $R_{\text{VS-U}} = 27.4\text{ k}\Omega$	$I_{\text{VS-Brown-IN}}$	395	465	535	$\mu\text{A}$
Brown-IN Debounce Time		$N_{\text{Brown-IN}}$	–	4	–	Pulse
Output Over-Voltage-Protection with Vs Sampling Voltage		$V_{\text{VS-OVP}}$	2.85	2.95	3.05	V

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## ELECTRICAL CHARACTERISTICS (continued)

For typical values  $T_J = 25^\circ\text{C}$ , for min/max values  $T_J = -40^\circ\text{C}$  to  $125^\circ\text{C}$ ,  $V_{DD} = 12\text{ V}$ ; unless otherwise noted.

Parameter	Test Conditions	Symbol	Min	Typ	Max	Unit
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### VOLTAGE-SENSE SECTION

Output Over-Voltage-Protection Debounce Pulse Counts		$N_{VS-OVP}$	–	4	–	Pulse
Output Under-Voltage-Protection with $V_S$ Sampling Voltage		$V_{VS-UVP-L}$	1.50	1.60	1.70	V
Output Under-Voltage-Protection Debounce Pulse Counts		$N_{VS-UVP}$	–	4	–	Pulse
Output Under-Voltage Protection Blanking Time at start-up		$t_{VS-UVP-BLANK}$	30	40	50	ms

### DYNAMIC RESPONSE ENHANCEMENT

Dynamic Event Enable Threshold Voltage	$T_J = 25^\circ\text{C}$	$V_{VS-EAV-DYN-EN}$	2.413	2.45	2.488	V
Dynamic Event Disable Threshold Voltage		$V_{VS-EAV-DYN-DIS}$		2.475		V
Hi-Z Mode Enable Time		$t_{HIZ-EN}$	90	100	110	$\mu\text{s}$
Hi-Z Mode Clamping Voltage		$V_{CLMP-HIZ}$	1.0	1.4	1.8	V

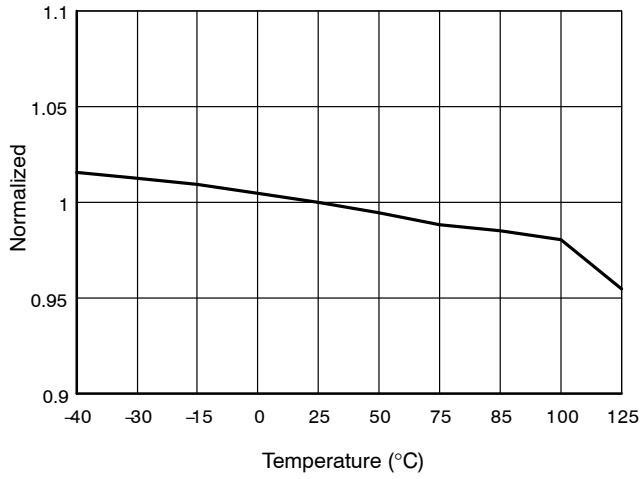
### GATE SECTION

Gate Output Voltage Low		$V_{GATE-L}$	0	–	1.5	V
Internal Gate PMOS Driver ON		$V_{DD-PMOS-ON}$	7.0	7.5	8.0	V
Internal Gate PMOS Driver OFF		$V_{DD-PMOS-OFF}$	9.0	9.5	10.0	V
Rising Time		$t_r$	100	140	180	ns
Falling Time		$t_f$	30	50	70	ns
Gate Output Clamping Voltage		$V_{GATE-CLAMP}$	7.0	7.5	8.0	V
Maximum On Time		$t_{ON-MAX}$	15	–	22	$\mu\text{s}$

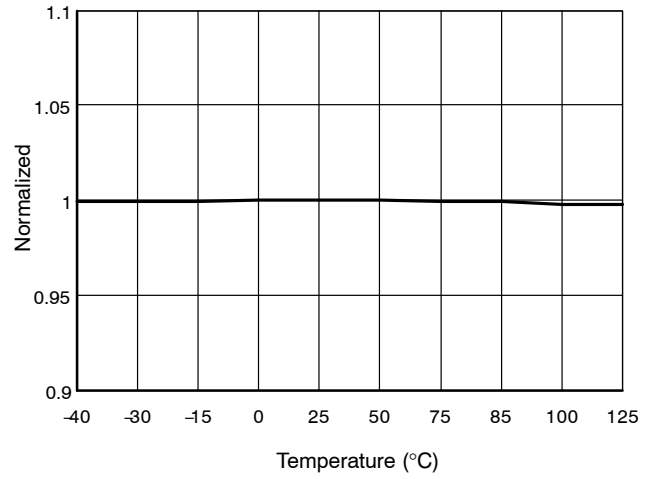
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

5. Design guaranteed.

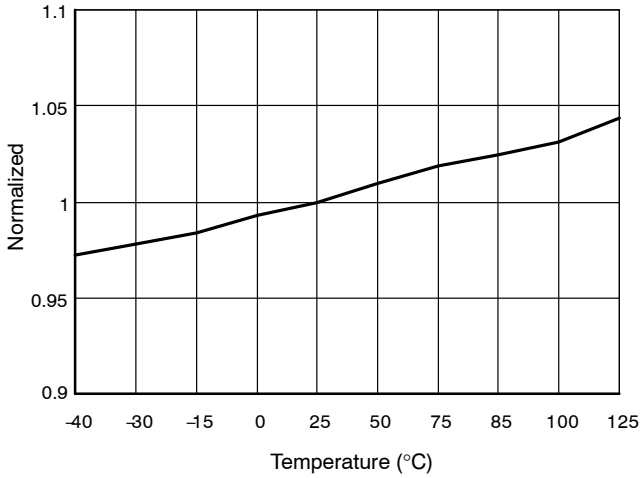
TYPICAL CHARACTERISTICS



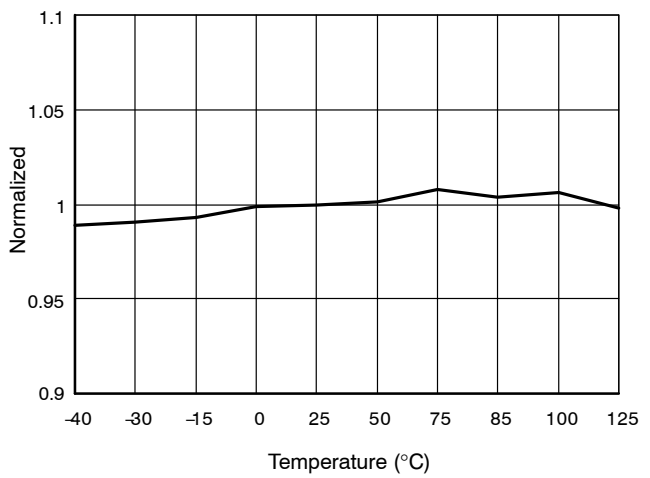
**Figure 4. Turn-On Threshold Voltage ( $V_{DD-ON}$ ) vs. Temperature**



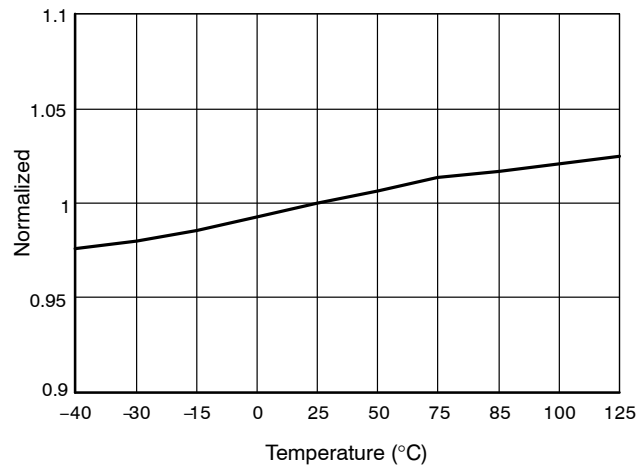
**Figure 5. Turn-Off Threshold Voltage ( $V_{DD-OFF}$ ) vs. Temperature**



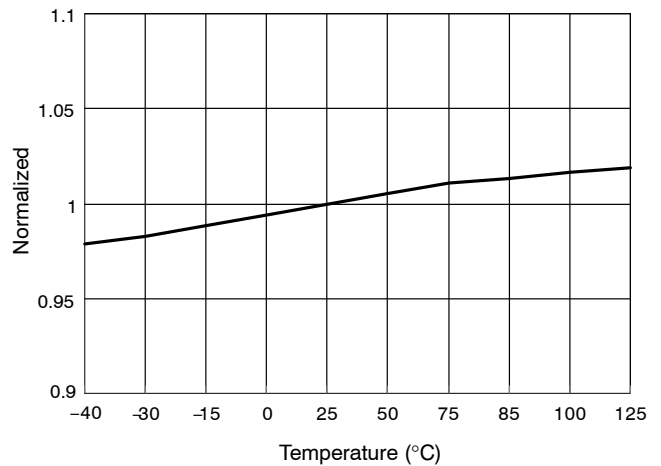
**Figure 6. VS Source Current Threshold to Enabled Brown-IN ( $I_{YS-Brown-IN}$ ) vs. Temperature**



**Figure 7. VS Source Current Threshold to Enabled Brown-OUT ( $I_{YS-Brown-OUT}$ ) vs. Temperature**



**Figure 8. Maximum Blanking Frequency ( $f_{BNK-MAX}$ ) vs. Temperature**



**Figure 9. Minimum Blanking Frequency ( $f_{BNK-MIN}$ ) vs. Temperature**

TYPICAL CHARACTERISTICS (continued)

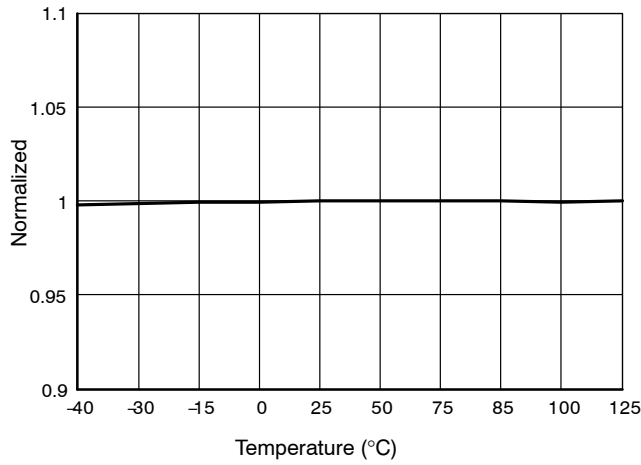


Figure 10. Reference Voltage of Constant Voltage ( $V_{VR-CV}$ ) vs. Temperature

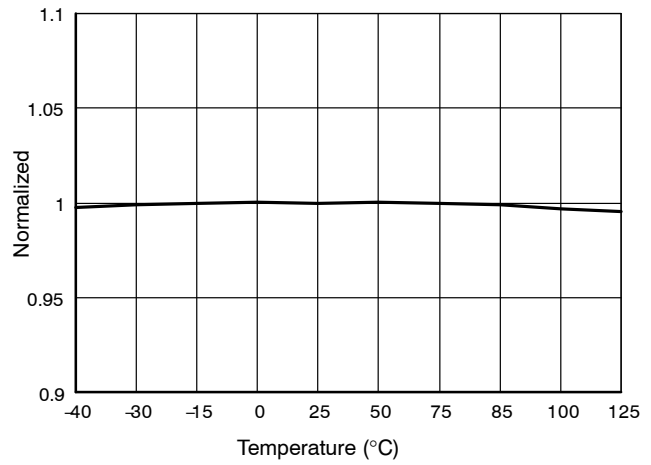


Figure 11. Reference Voltage of Constant Current ( $V_{VR-CC}$ ) vs. Temperature

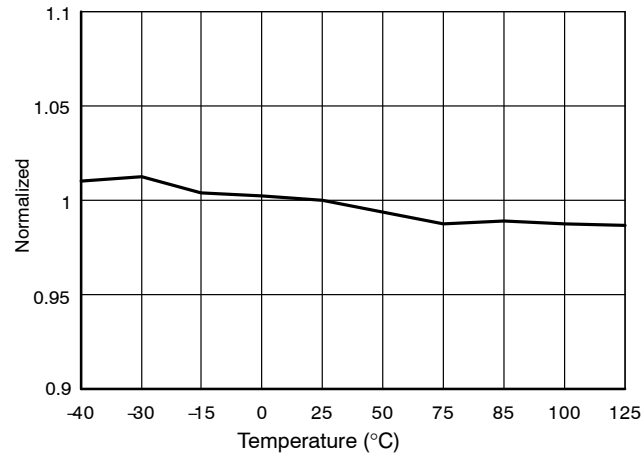


Figure 12. VS Sampling Blanking Time L ( $t_{VS-BNK-L}$ ) vs. Temperature

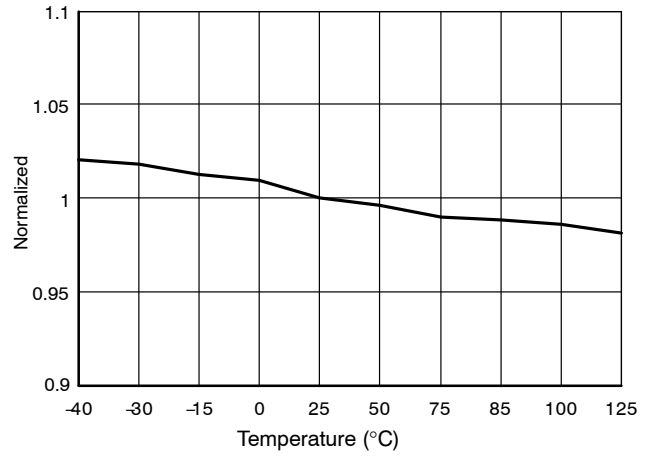


Figure 13. VS Sampling Blanking Time H ( $t_{VS-BNK-H}$ ) vs. Temperature

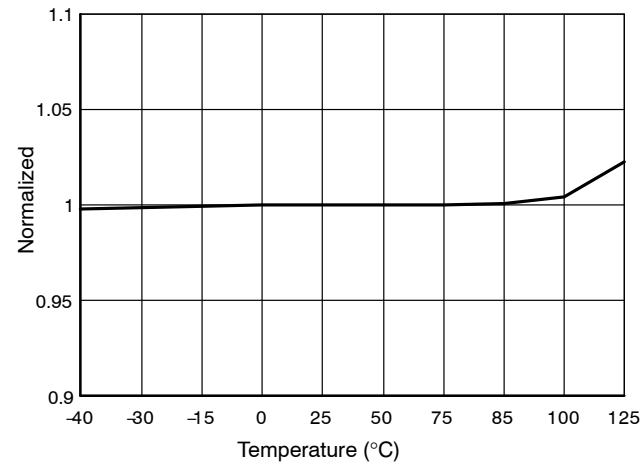


Figure 14. Output Over-Voltage-Protection ( $V_{VS-OVP}$ ) vs. Temperature

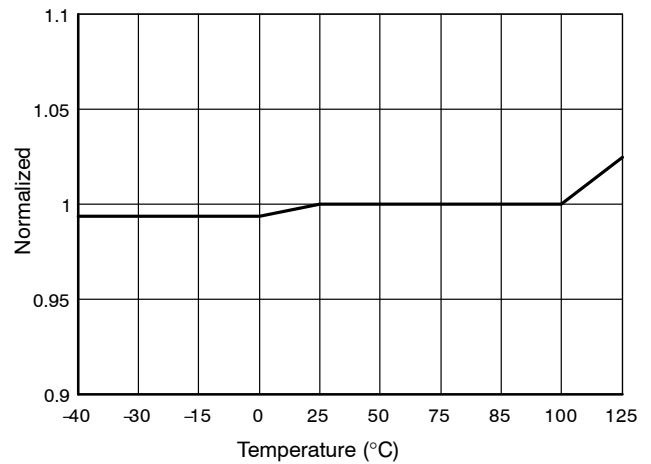
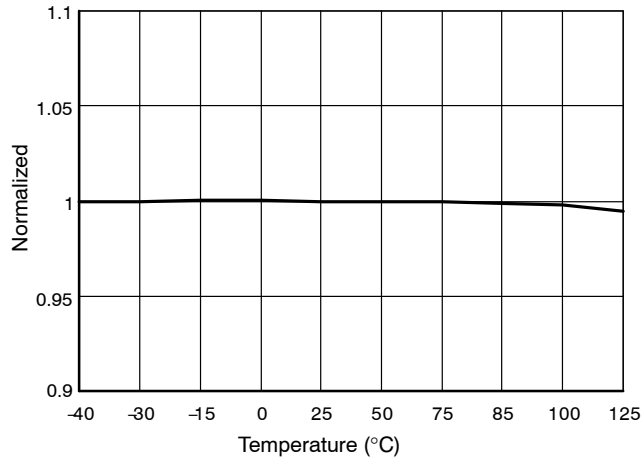


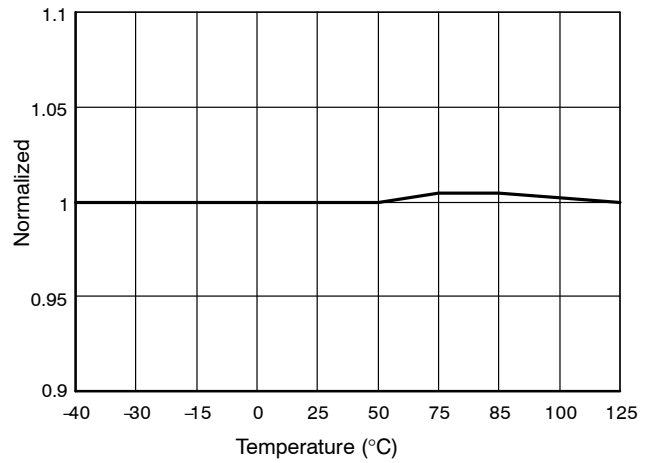
Figure 15. Output Under-Voltage Protection ( $V_{VS-UVp}$ ) vs. Temperature

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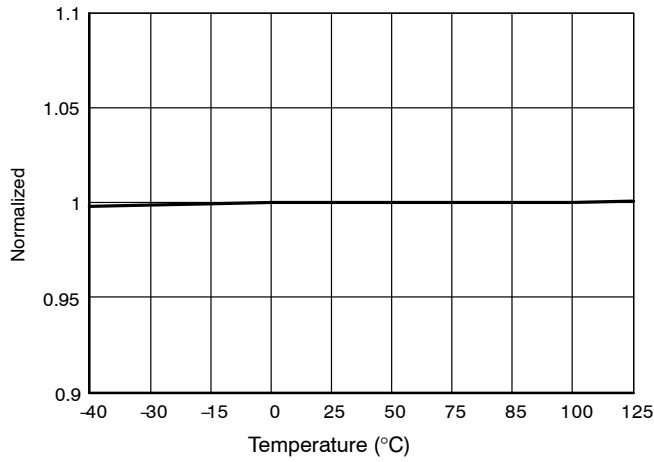
## TYPICAL CHARACTERISTICS (continued)



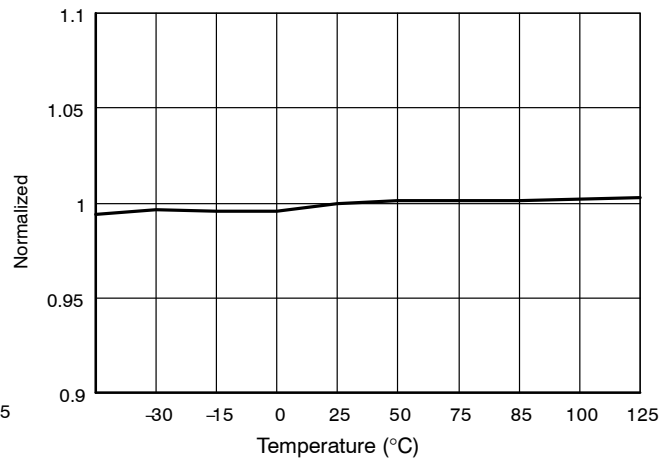
**Figure 16. Current Limit Threshold Voltage ( $V_{CS-LIM}$ ) vs. Temperature**



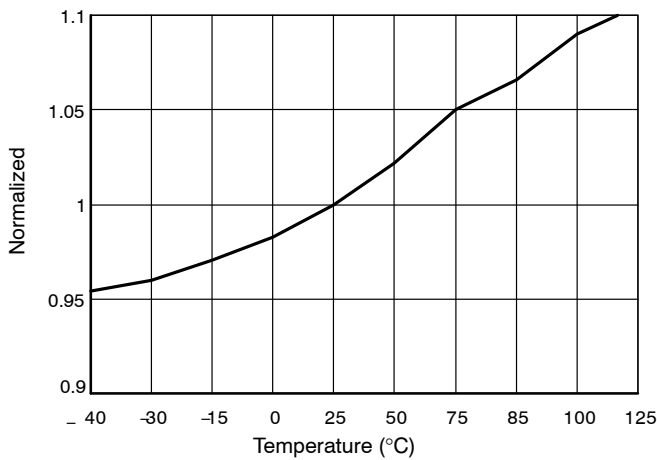
**Figure 17. High Threshold Voltage of Current Sense ( $V_{CS-IMIN}$ ) vs. Temperature**



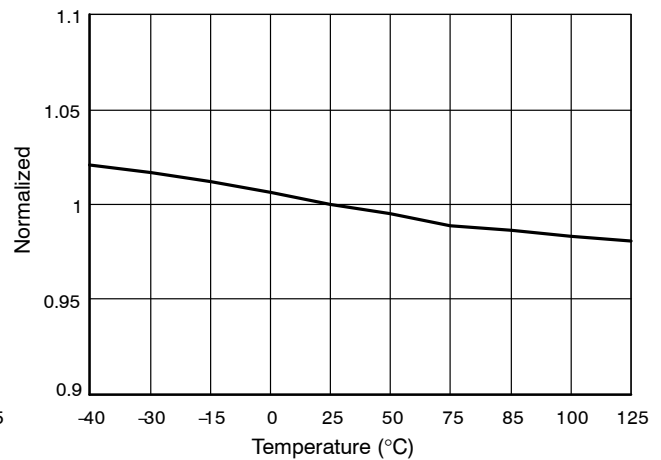
**Figure 18.  $V_{DD}$  Over-Voltage Protection Level ( $V_{DD-OVP}$ ) vs. Temperature**



**Figure 19. Cable Drop Compensation Voltage ( $\Delta V_{DC}$ ) vs. Temperature**



**Figure 20. Leading-Edge Blanking Time ( $t_{LEB}$ ) vs. Temperature**



**Figure 21. Maximum On Time ( $t_{ON-MAX}$ ) vs. Temperature**

## APPLICATIONS INFORMATION

FAN1080 is a flyback power supply controller providing a means to implement primary side constant-voltage (CV) and constant-current (CC) regulation. This technique can simplify feedback circuit and secondary side circuit compare to traditional flyback converter. FAN1080 implements a current-mode architecture operation in quasi-resonant mode. The quasi-resonant mode operation is able to minimize the switching loss to optimize the power supply efficiency and get better EMI performance.

FAN1080 quasi-resonance operation in peak current mode control is monitor the auxiliary winding voltage on primary side via the resistor divider to voltage sense pin (VS) and current sense pin (CS). Extremely accurately constant voltage (CV) mode and constant current (CC) mode could meet strict requirement from market.

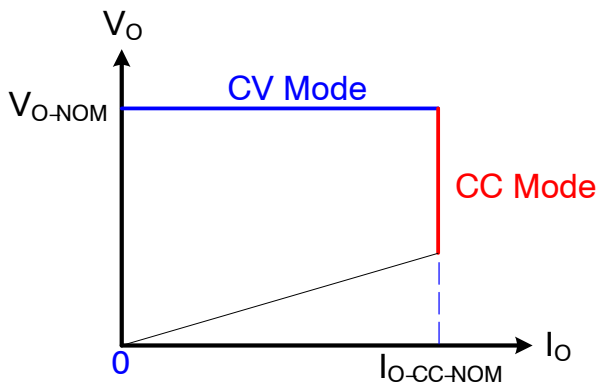


Figure 22. CV and CC Mode

FAN1080 implements deep green mode (DPGN) with lowest switching frequency, limits IC current consumption (460  $\mu$ A) for excellent system standby power performance. Furthermore, the system design allows two kinds of startup circuit one is with startup resistor the other is with high voltage FET.

Protections such as over-voltage protection (VS-OVP), under-voltage protection (VS-UVP), internal over-temperature protection (OTP), brown-in and brown-out protection, cycle by cycle current limit, current sense resistor short protection and secondary rectifier short protection.

## Startup Operation

FAN1080 supports high voltage start up with depletion FET that can make better standby power and shorter start up time. Figure 23 shows startup sequence with AUX controlling. The initial AUX pin status should be defined by resistor of  $R_D$ . At system power on moment, the initial  $V_{DD}$  voltage is zero, internal switch S1 is turn-on and external depletion FET also is turn-on, the  $C_{VDD}$  is charged through depletion FET till  $V_{DD}$  reach  $V_{DD-ON}$ . While internal switch S1 is turn-off and  $V_{GS}$  of depletion FET will close to internal clamping voltage ( $V_{CLAMP}$ ) which less than depletion FET  $V_{GS}$  turn-on threshold. Meanwhile  $V_{DD}$  energy supplement is turn to auxiliary winding. The voltage gap between  $V_{DD}$  and  $V_{AUX}$  is kept at  $\Delta V_{CLAMP}$  till controller shut-down by protection or  $V_{DD}$  touching  $V_{DD-OFF}$ .

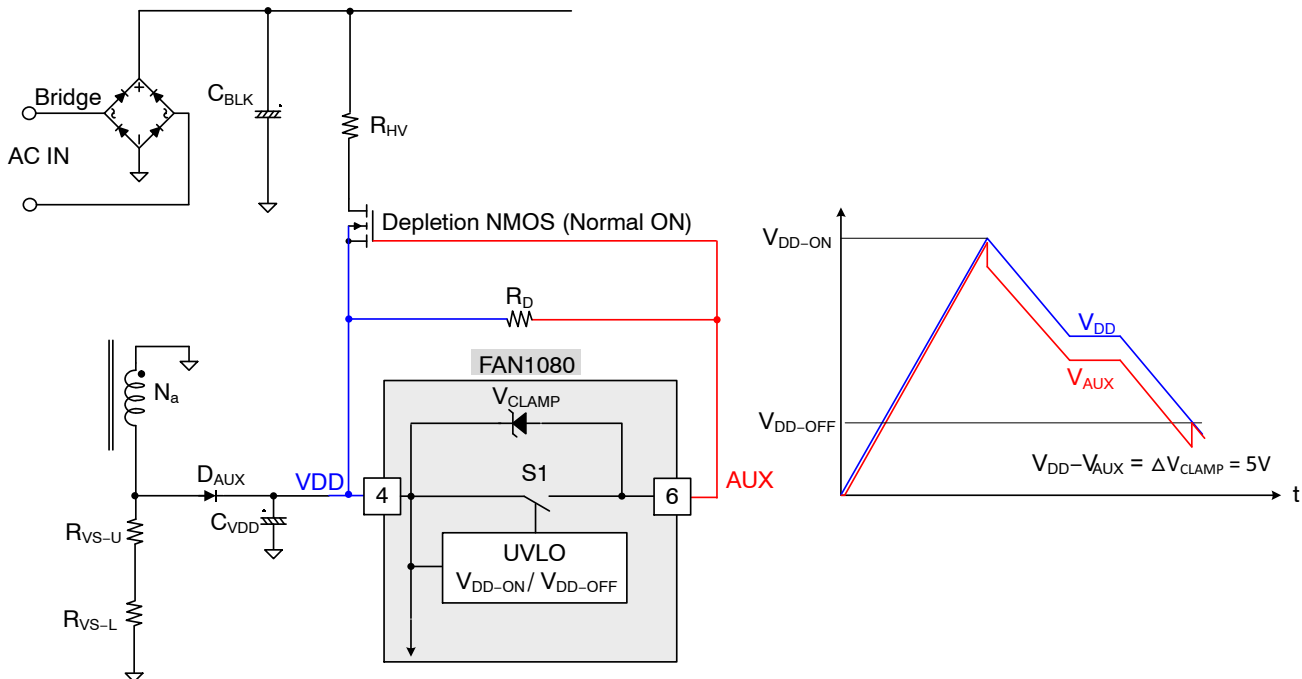


Figure 23. Startup Sequence with AUX Controlling

### Primary Side Regulation: Constant Voltage Operation

As illustrated by Figure 24, the voltage of auxiliary winding ( $V_{WAUX}$ ) is reflected to output voltage scaled by the auxiliary and secondary turns ratio minus the drain voltage of synchronous rectifier (SR) FET.

To reach an accurate primary-side constant-voltage regulation, the controller detects the end of the demagnetization time and precisely sample output voltage level seen on the auxiliary winding.

Therefore, when the secondary current  $I_{SEC}$  reaches zero ampere, the voltage of auxiliary winding is sensed as:

$$V_{WAUX} = V_O \times \frac{N_a}{N_s} \quad (\text{eq. 1})$$

where  $N_a$  and  $N_s$  are respectively the turns of secondary and auxiliary.

Figure 25 shows how the constant voltage feedback has been built. The auxiliary winding voltage must be scaled down via the resistor divider to  $V_{VR-CV}$  level before building the constant voltage feedback error.

$$V_{VR-CV} = \frac{R_{VS-L}}{R_{VS-U} + R_{VS-L}} \times V_{WAUX} \quad (\text{eq. 2})$$

By inserting Equation 1 into Equation 2 we obtain the following equation:

$$V_{VR-CV} = \frac{R_{VS-L}}{R_{VS-U} + R_{VS-L}} \times V_O \times \frac{N_a}{N_s} \quad (\text{eq. 3})$$

A VS blanking time ( $t_{VS-BNK}$ ) start from primary switch turned off. Most of TA design has VS oscillation after primary switch turned off that is caused by the resonance of leakage inductance and parasitic capacitance at transformer. In order to avoid VS sampling procedure get impacted by that ringing, after  $t_{VS-BNK}$  the oscillation should be settled down. Figure 25 shows feedback signal sampling timing, after the VS blanking time, the controller samples the VS pin voltage as  $V_{SD}$ . Once VS is lower than the threshold voltage of  $V_{TDIS}$  ( $V_S - 200 \text{ mV}$ ), the  $V_{SD}$  signal will be held as  $V_{S-SH}$ .

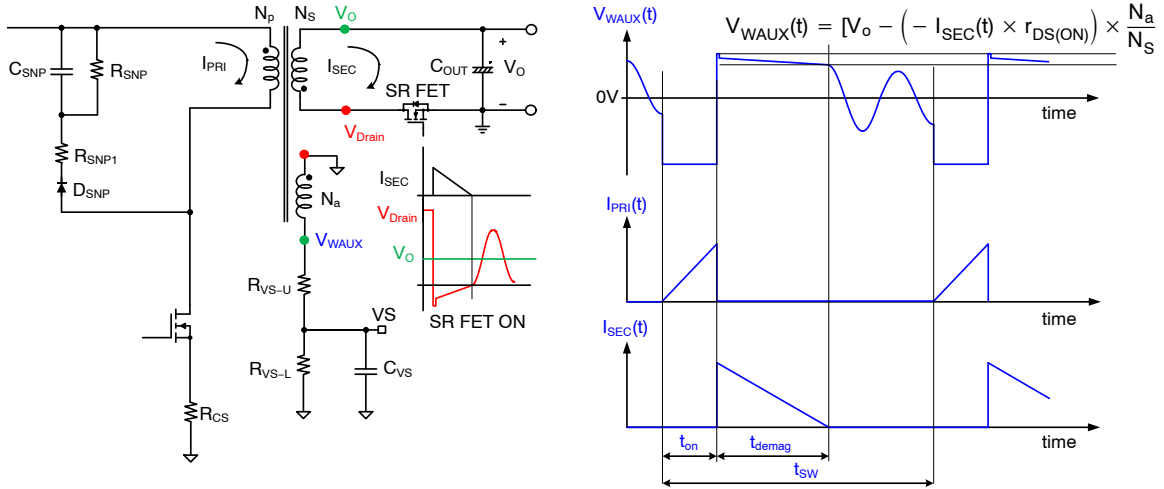


Figure 24. Typical Idealized Waveforms of a Flyback Transformer in DCM

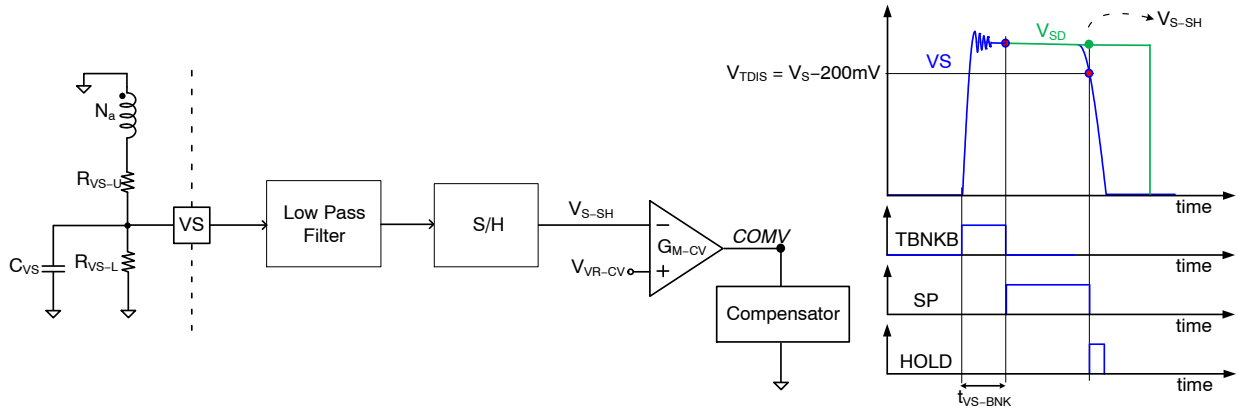


Figure 25. Constant Voltage Feedback Circuit and VS signal Sampling Timing

### Primary Side Regulation: Constant Current Operation

Figure 26 shows the key waveforms of a flyback converter operation in DCM. The output current ( $I_O$ ) is estimated by calculating the average of secondary current ( $I_{SEC}$ ) in one switching cycle. The output current ( $I_O$ ) can be calculated as

$$I_O = \frac{1}{2} \frac{1}{R_{CS}} \frac{V_{CS-PK} \cdot T_{DIS}}{T_{SW}} \frac{N_P}{N_S} \eta = \frac{1}{2} \frac{1}{R_{CS}} \frac{V_{VR-CC}}{A_{PK}} \frac{N_P}{N_S} \eta \quad (\text{eq. 4})$$

When the secondary current reaches zero, the transformer winding voltage begins to drop sharply, and VS pin voltage drops as well. When VS pin voltage drops below the  $V_S$  by

more than 200 mV, zero current point of secondary current is obtained.

The output current can be programmed by setting the current sensing resistor as:

$$R_{CS} = \frac{1}{2} \cdot \frac{1}{I_O} \cdot \frac{V_{VR-CC}}{A_{PK}} \cdot \frac{N_P}{N_S} \cdot \eta \quad (\text{eq. 5})$$

where  $V_{VR-CC}$  is the internal voltage for constant current control,  $\eta$  is efficiency of flyback and  $A_{PK}$  is the IC design parameter, 3.6 for FAN1080.

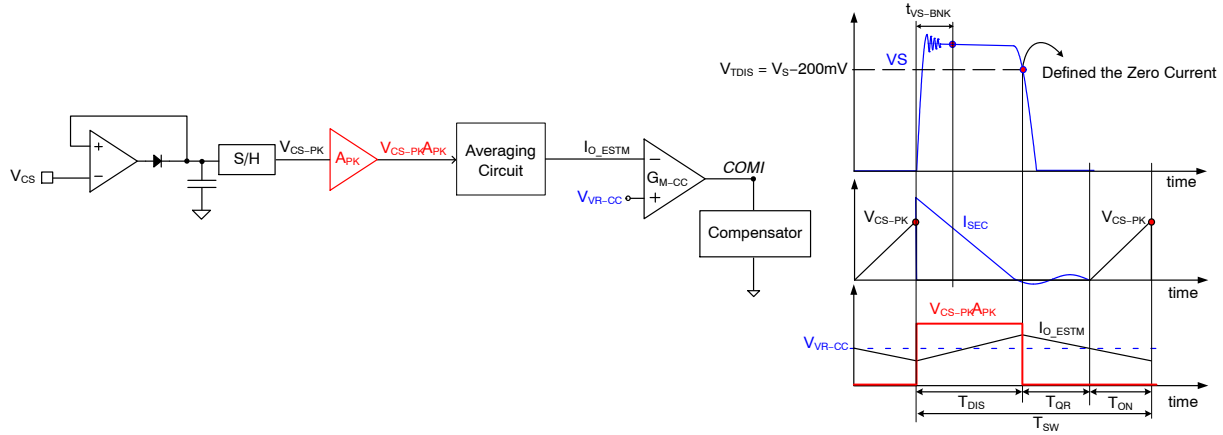


Figure 26. Constant Current Feedback Circuit and Control Sequence

### Line Voltage Compensation

The output current estimation is also affected by the turn-off delay of the power FET as shown in Figure 27. The actual power FET's turn-off time is delayed due to the FET gate charge and gate driver's capability, resulting in peak current detection error as

$$\Delta I_{DS}^{PK} = \frac{V_{BLK}}{L_m} \times t_{OFF.DLY} \quad (\text{eq. 6})$$

where  $L_m$  is the transformer's primary side magnetizing inductance and  $V_{BLK}$  is bulk voltage. Since the output current error is proportional to the line voltage, the FAN1080 incorporates line voltage compensation to improve output current estimation accuracy.

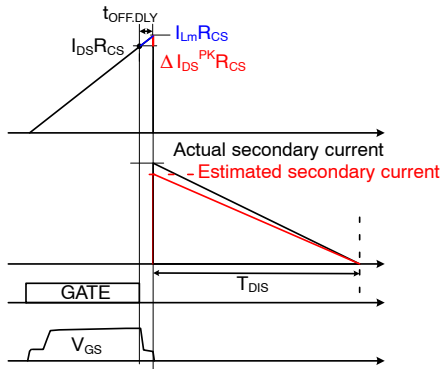


Figure 27. MOSFET Turn-off Delay

Line information is obtained through the line voltage detector as shown in Figure 29.  $I_{COMP}$  is an internal current source which is proportional to line voltage. The line compensation gain is programmed by using CS pin series resistor,  $R_{CS\_COMP}$  depending on the power FET turn-off delay ( $t_{OFF.DLY}$ ).  $I_{COMP}$  creates a voltage drop ( $V_{OFFSET}$ ) across  $R_{CS\_COMP}$ . This line compensation offset is proportional to the DC link capacitor voltage ( $V_{BLK}$ ) and turn-off delay ( $t_{OFF.DLY}$ ). Figure 28 demonstrates the effect of the line compensation.

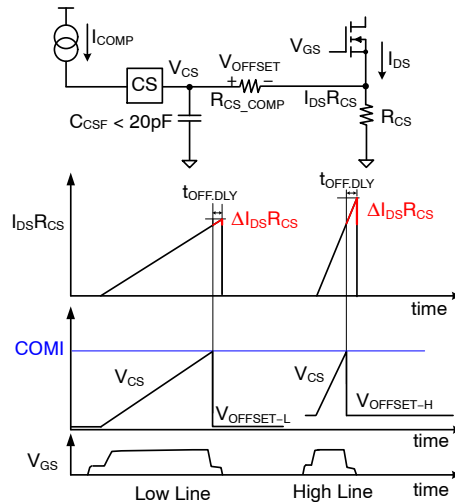


Figure 28. Line Voltage Compensation

### CV / CC PWM Control Principle

Figure 29 shows a simplified CV / CC PWM control circuit of the FAN1080. The Constant Voltage (CV) regulation is implemented internally with primary-side control. The output signal of compensation (COMV) is scaled down by attenuator  $A_{V-CV}$  to generate a  $V_{FB-CV}$  signal. This  $V_{FB-CV}$  signal is applied to the PWM comparator to determine the duty cycle.

The Constant Current (CC) regulation is implemented internally with primary-side control. The output current estimator calculates the output current using the transformer primary-side current and secondary current discharge time ( $T_{DIS}$ ). By comparing the estimated output current with internal reference signal, a COMI signal is generated. The

COMI signal is scaled down by attenuator  $A_{V-CC}$  to generate a  $V_{FB-CC}$  signal. This  $V_{FB-CC}$  signal is applied to the PWM comparator to determine the duty cycle.

These two control signals,  $V_{FB-CV}$  and  $V_{FB-CC}$  are compared with a voltage of current sense ( $V_{CS}$ ) by two PWM comparators to determine the duty cycle. Figure 29 illustrates the outputs of two comparators combined with an OR gate, to determine the power FET turn-off instant. Either of  $V_{FB-CV}$  or  $V_{FB-CC}$ , the lower signal determines the duty cycle. During CV regulation,  $V_{FB-CV}$  determines the duty cycle while  $V_{FB-CC}$  is saturated to HIGH level. During CC regulation,  $V_{FB-CC}$  determines the duty cycle while  $V_{FB-CV}$  is saturated to HIGH level.

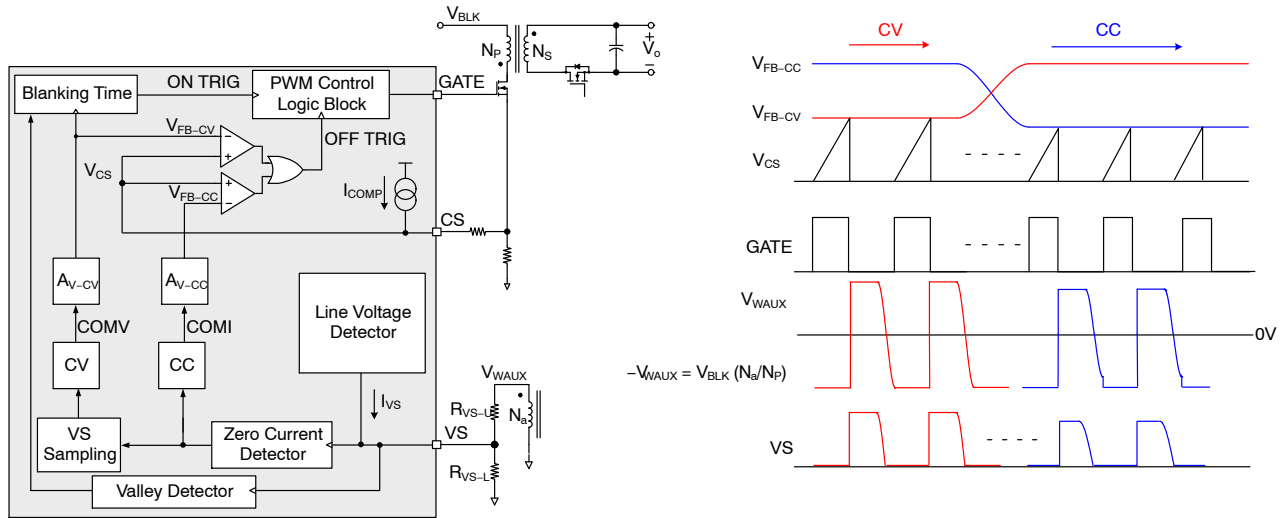


Figure 29. Simplified PSR Flyback Converter Circuit

### Valley Detection and Frequency Fold-back

The quasi-resonant (QR) switching is a method to reduce primary side switching losses. To perform QR turn-on of the power FET, the valley of the resonance occurring between transformer magnetizing inductance ( $L_m$ ) and effective output capacitance ( $C_{oss-eff}$ ) must be detected.

The resonant period is detected by monitoring the time of 1/4 resonant period from end of secondary current discharge time ( $T_{DIS}$ ) to VS signal reaches zero. FAN1080 will turn on the power FET at 1/2 resonant period after the blanking frequency as shown in Figure 30.

For heavy load condition, the blanking time for the valley detection is fixed and primary side peak current will be modulated by voltage level of feedback ( $V_{FB-CV}$ ). For the medium load condition, the blanking time is modulated as a function of load current such that the upper limit of the blanking frequency varies from  $f_{BNK-MAX}$  as load decreases where the blanking frequency reduction stop point is  $f_{BNK-MIN}$ . For the light load condition, the peak of  $V_{CS}$  is fixed by  $V_{CS-IMIN}$  (0.225 V) and the energy will be modulated by the function of Pulse Frequency Modulation (PFM), as shown in Figure 31.

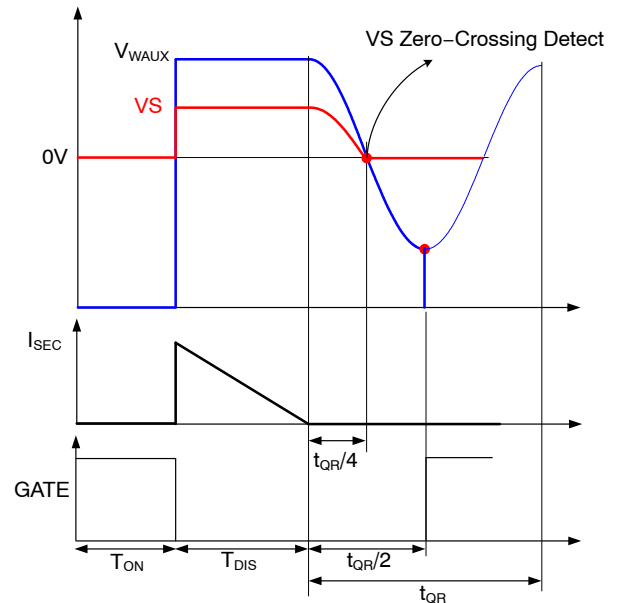


Figure 30. Valley Detection

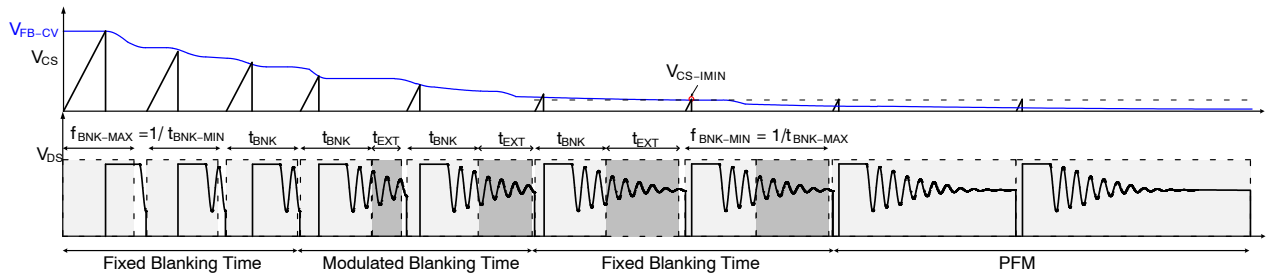


Figure 31. Frequency Fold-back Function

### Cable Drop Compensation (CDC)

FAN1080 integrates cable drop compensation function; this circuitry compensates the drop due to the cable connected between the PCB output of the charger and the final equipment. As the drop is linearly varying with the output current level, this level can be compensated by accounting for the load output current.

The weighting of CDC provides a constant output voltage at the end of the cable over the entire load range in CV mode. The voltage of cable drop compensation at output is proportional to VS compensation weighting that is internal reference voltage with CDC compensation as

$$V_O = \frac{N_S}{N_A} \left( 1 + \frac{R_{VS-U}}{R_{VS-L}} \right) \times \left( V_{VR-CV} + \Delta V_{CDC} \times \frac{I_O}{I_{O-CC-NOM}} \right) \quad (\text{eq. 7})$$

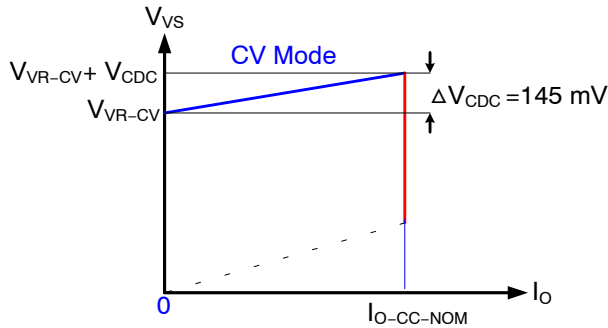


Figure 32. CV-CC Curve with CDC

### Protections

The FAN1080 self-protection includes VDD Over-Voltage-Protection (VDD-OVP), Internal Chip Over-Temperature-Protection (OTP), VS Over-Voltage Protection (VS-OVP), VS Under-Voltage Protection (VS-UVP), CS pin Protection (CSP), Brown-out and Brown-In protection, and all of protection are implemented as Auto Restart (AR) mode. When the Auto-Restart Mode protection is triggered, switching is terminated and the power FET remains off, causing VDD to drop because of IC

operating current  $I_{DD-OP}$  (1.2 mA). When VDD drops to the VDD turn-off voltage  $V_{DD-OFF}$  (6.5 V), operation current reduces to  $I_{DD-ST}$  (20  $\mu$ A) and the protection is reset and the supply current drawn from bulk capacitor begins to charge the VDD hold-up capacitor. When VDD reaches the turn-on voltage  $V_{DD-ON}$  (17.5 V), the FAN1080 resumes normal operation. In this manner, the Auto-Restart mode alternately enables and disables the switching of the power FET until the abnormal condition is eliminated as shown in Figure 33.

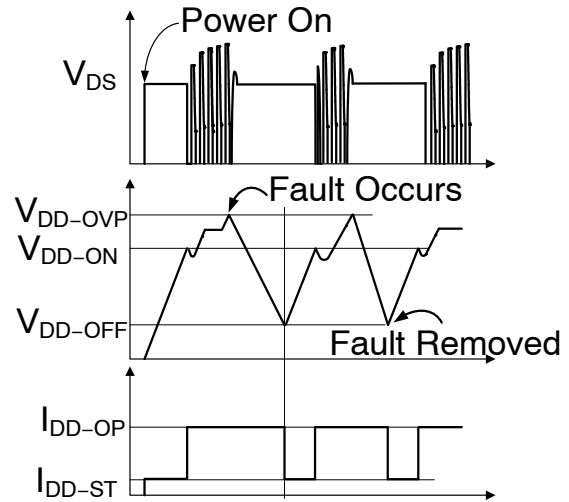


Figure 33. Auto-Restart Mode Operation

### VDD Over-Voltage-Protection (VDD-OVP)

VDD over-voltage protection prevents IC damage from over-voltage stress. It is operated in Auto-Restart mode. When the VDD voltage exceeds  $V_{DD-OVP}$  (28 V) for the de-bounce time,  $t_{D-VDDOVP}$  (120  $\mu$ s), due to abnormal condition, the protection is triggered. This protection is typically caused by the auxiliary winding turns are too many, load regulation is not good between transformer winding, VS information is not available anyhow and so on.

### Brown-In and Brown-Out

Line voltage information is used for brown-out and brown-in protection. When the  $I_{VS}$  current out of the VS pin during the power FET conduction time is less than  $I_{VS-Brown-OUT}$  (320  $\mu A$ ) for longer than 17 ms, the brown-out is triggered. The brown-out is set to around 20% margin of the minimum voltage on the bulk capacitor to allow adapter deliver maximum power under the low line full load condition. The input bulk capacitor voltage to trigger brown-out protection is given as

$$V_{BO} = \frac{V_{BLK-MIN}}{1.2} = I_{VS-Brown-OUT} \times \frac{R_{VS-U}}{\frac{N_a}{N_p}} \quad (\text{eq. 8})$$

where  $V_{BLK-MIN}$  is the minimum voltage on the bulk capacitor.

For the brown-in protection, when the  $I_{VS}$  current out of the VS pin during the power FET conduction time is over than  $I_{VS-Brown-OUT}$  (465  $\mu A$ ) for more than 4 consecutive switching cycles, the brown-in is triggered. The input bulk capacitor voltage to trigger brown-in protection is given as

$$V_{BI} = I_{VS-Brown-IN} \times \frac{R_{VS-U}}{\frac{N_a}{N_p}} \quad (\text{eq. 9})$$

### VS Over-Voltage Protection (VS-OVP)

VS over-voltage protection prevents damage caused by output over-voltage condition. It is operated in Auto-Restart mode. Figure 34 shows the internal circuit of VS-OVP protection. When abnormal system conditions occur, which cause VS sampling voltage to exceed  $V_{VS-OVP}$  (2.95 V) for more than de-bounce cycles ( $N_{VS-OVP}$ ), PWM pulses are disabled and FAN1080 enters Auto-Restart protection. VS over-voltage conditions are usually caused by open circuit of the feedback network or a fault condition in the VS pin voltage divider resistors. For VS pin voltage divider design,  $R_{VS-U}$  is obtained from Equation 8 and 9 and  $R_{VS-L}$  is determined by Equation 3.  $V_{O-OVP}$  can be determined by Equation 10

$$V_{O-OVP} = \frac{N_s}{N_a} \left( 1 + \frac{R_{VS-U}}{R_{VS-L}} \right) \times V_{VS-OVP} \quad (\text{eq. 10})$$

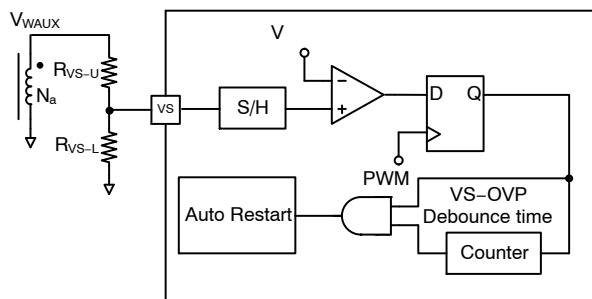


Figure 34. VS-OVP Protection Circuit

### VS Under-Voltage Protection (VS-UVP)

In the event of an output short, output voltage will drop and the primary peak current will increase. To prevent operation for a long time in this condition, FAN1080 incorporates under-voltage protection through VS pin. Figure 35 shows the internal circuit for VS-UVP. By sampling the auxiliary winding voltage on the VS pin at the end of SR FET conduction time, the output voltage is indirectly sensed. When VS sampling voltage is less than  $V_{VS-UVP}$  (1.6 V) and longer than de-bounce cycles  $N_{VS-UVP}$ , VS-UVP is triggered and the FAN1080 enters Auto-Restart Mode.

To avoid VS-UVP triggering during the startup sequence a startup blanking time,  $t_{VS-UVP-BLANK}$  (40 ms), is included when system is power-on. For VS pin voltage divider design,  $R_{VS-U}$  is obtained from Equation 8, 9 and  $R_{VS-L}$  is determined by Equation 3.  $V_{O-UVP}$  can be determined by Equation 11.

$$V_{O-UVP} = \frac{N_s}{N_a} \left( 1 + \frac{R_{VS-U}}{R_{VS-L}} \right) \times V_{VS-UVP} \quad (\text{eq. 11})$$

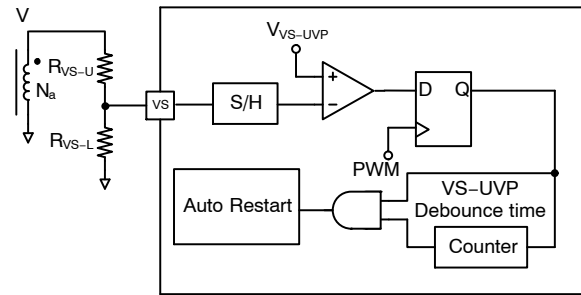


Figure 35. VS-UVP Protection Circuit

### Cycle-by-Cycle Current Limit

During startup or overload condition, the feedback loop is saturated to high and is unable to control the primary peak current. To limit the current during such conditions, FAN1080 has cycle-by-cycle current limit protection which forces the GATE to turn off when the CS pin voltage reaches the current limit threshold,  $V_{CS-LIM}$  (0.7 V).

### Secondary-Side Diode Shot Protection

When the secondary-side diode is damaged, the slope of the primary-side peak current will be sharp within leading-edge blanking time. To limit the current during such conditions, FAN1080 has secondary-side diode short protection which forces the GATE to turn off when the CS pin voltage reaches 1.6 V. After one switching cycle, it will operate in Auto-Restart mode as shown in Figure 36.

### Current Sense Short Protection

Figure 36 shows the internal circuit of current sense short protection. When abnormal system conditions occur, which cause CS pin voltage lower than 0.2 V PWM pulses are disabled and FAN1080 enters Cycle-by-Cycle protection. The  $I_{CS-Short}$  is an internal current source, which is proportional to line voltage. The de-bounce time ( $t_{CS-Short}$ ) is created by  $I_{CS-Short}$ , capacitor (1 pF) and threshold voltage (2.0 V). This de-bounce time ( $t_{CS-Short}$ ) is inversely proportional to the DC link capacitor voltage,  $V_{BLK}$ .

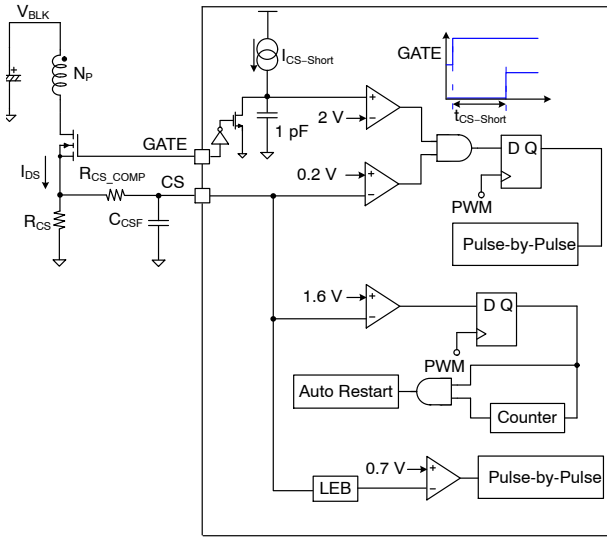


Figure 36. Current Sense Protection Circuit

### Dynamic Response Enhancement (DRE)

PSR flyback converter regulates output voltage within requirement specification through detects  $V_S$  signal which proportional to output voltage. However  $V_S$  signal can only detect when power FET is switched. To get better standby power performance, the switching frequency is decreases to quite low frequency, the output voltage cannot be maintained as load suddenly increases from extremely light load to heavy load during such conditions. Therefore, FAN1080 build in a Dynamic Response Enhancement (DRE) function to detect output voltage dropping immediately when FAN1080 pair with FAN6250. Figure 37 shows DRE function relative signal working sequence. In the light load to no load condition, when the time of switching period is longer than time  $t_{HIZ-EN}$  (100  $\mu s$ ), the Hi-Z mode will be enabled which is let GATE pin become high impedance. Therefore, the GATE pin is changed from output to input and the signal on the GATE pin can be received.

FAN6250 VIN pin can detect the output voltage ( $V_O$ ). When  $V_O$  is lower than the threshold of  $V_{DRE}$ , the FAN6250 drain pin will sink a current ( $I_{DRE}$ ) from the secondary winding to ground and this current is via the transformer to primary side. Because of the transformer leakage inductance and the drain lumped capacitance, some voltage ringing

appears on the drain node. The FAN1080 GATE pin can receive the voltage ringing via  $C_{DS}$  and  $C_{GS}$ , is given as

$$V_{GATE} = \frac{C_{GD}}{C_{GD} + C_{GS}} \times V_{Drain} \quad (\text{eq. 12})$$

Once GATE pin received the signal of voltage ringing, FAN1080 will turn on the power FET immediately and get output voltage information via  $V_S$  pin. If the voltage of  $V_S$  pin is lower than the threshold of  $V_{VS-DNY-EN}$ , the switching frequency increases immediately.

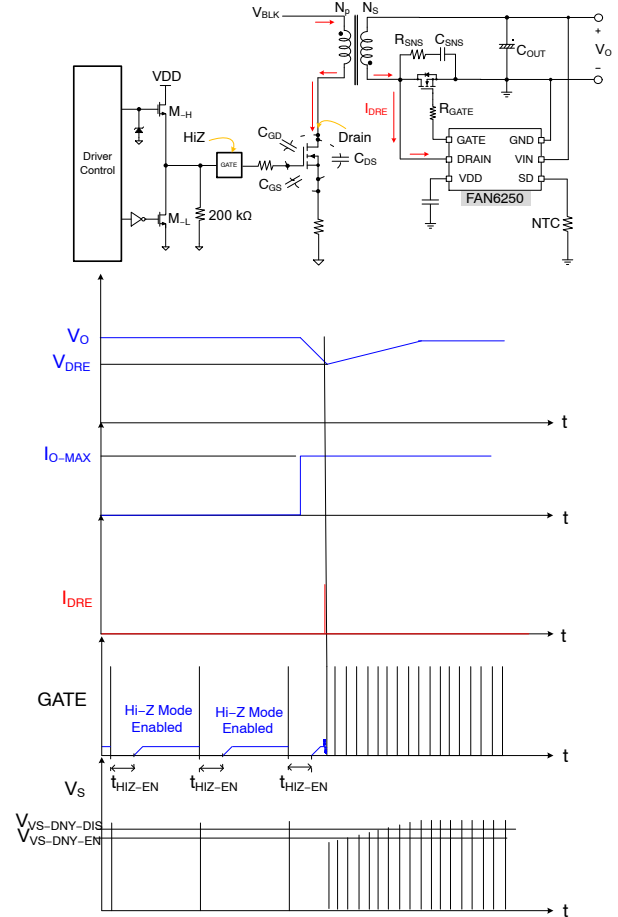


Figure 37. DRE Function Detecting Sequence

### PCB Layout Guideline

Print circuit board (PCB) layout and design are very import for switching power supplies where the voltage and current change with high  $dv/dt$  and  $di/dt$ . A good PCB layout minimizes excessive EMI and prevents the power supply from being disrupted during surge/ESD tests. The following guidelines are recommended for layout designs.

- To improve EMI performance and reduce line frequency ripples, the output of the bridge rectifier should be connected to capacitors  $C_{BLK1}$  and  $C_{BLK2}$  first, then to the transformer and MOSFET
- The primary-side high-voltage current loop is  **$C_{BLK2}$  – Transformer – MOSFET –  $R_{CS}$  –  $C_{BLK2}$** . The area

## FAN1080M6X

enclosed by this current loop should be as small as possible. The trace for the control signal (CS, VS and GATE) should not go across this primary high-voltage current loop to avoid interference

- Place  $R_{HV}$  for protection against the inrush spike on the drain pin of depletion FET (200 k $\Omega$  is recommended).  $R_{CS}$  should be connected to the ground of  $C_{BLK2}$  directly. Keep the trace short and wide (Trace 4 to 1) and place it close to the CS pin to reduce switching noise. High-voltage traces related to the drain of MOSFET and RCD snubber should be away from control circuits to prevent unnecessary interference. If a heat sink is used for the MOSFET, connect this heat sink to ground
- As indicated by 2, the area enclosed by the transformer auxiliary winding,  $D_{AUX}$  and  $C_{VDD}$ , should also be small
- Place  $C_{VDD}$ ,  $C_{VS}$ ,  $R_{VS-L}$ ,  $R_{CS\_COMP}$  and  $C_{CSF}$  close to the controller for good decoupling and low switching noise
- As indicated by 3, the ground of the control circuits should be connected as a single point first, then to other circuitry

- Connect ground by 3 to 2 to 4 to 1 sequence. This helps to avoid common impedance interference for the sense signal
- Regarding the ESD discharge path, use the shortcut pad between AC line and DC output (most recommended). Another method is to discharge the ESD energy to the AC line through the primary-side main ground 1. Because ESD energy is delivered from the secondary side to the primary side through the transformer stray capacitor or the Y capacitor, the controller circuit should not be placed on the discharge path. 5 shows where the point-discharge route can be placed to effectively bypass the static electricity energy
- For the surge path, select fusible resistor of wire wound type to reduce inrush current and surge energy and use  $\pi$  input filter (two bulk capacitors and one inductance) to share the surge energy

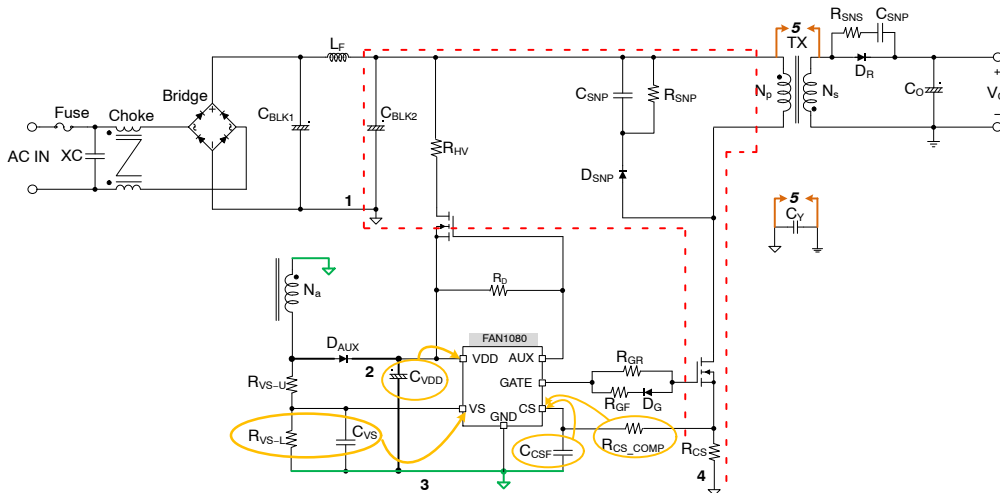


Figure 38. Recommended Layout for FAN1080

### ORDERING INFORMATION

Device	Operating Temperature Range	Package	Shipping <sup>†</sup>
FAN1080M6X	-40°C to +125°C	6-Lead, SOT23 (Pb-Free / Halogen Free)	3,000 / Tape & Reel

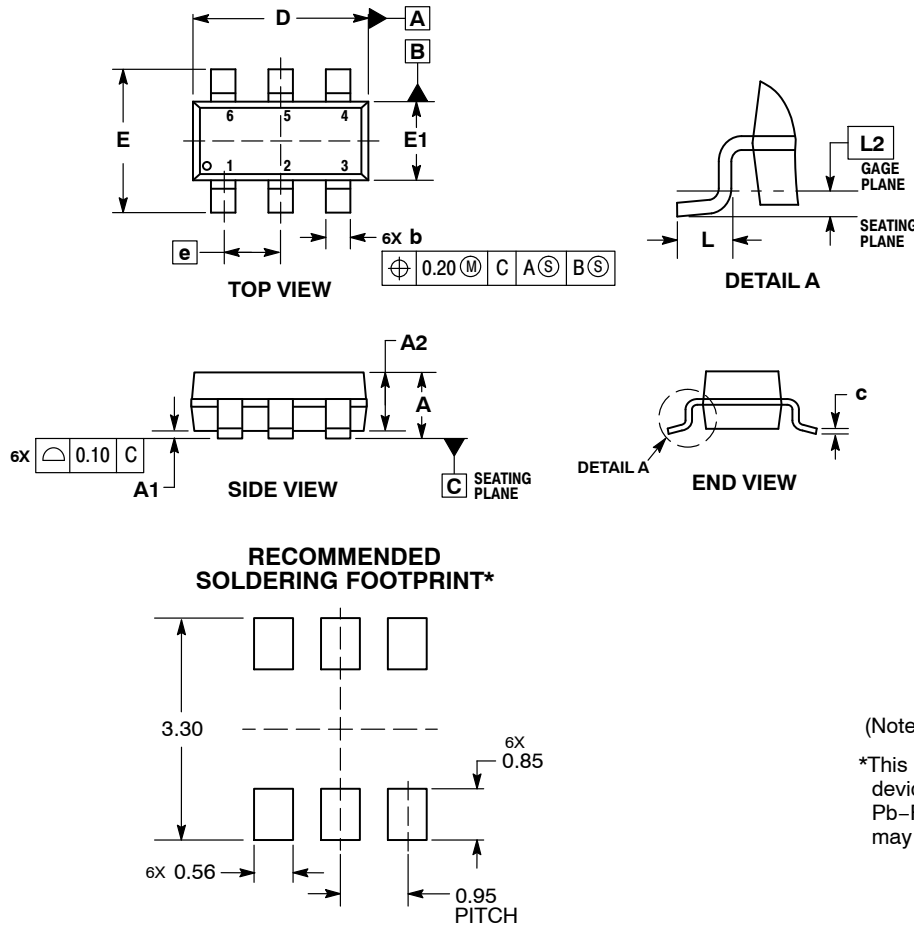
<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, [BRD8011/D](#).



SCALE 2:1

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**CASE 527AJ**  
**ISSUE B**

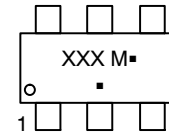
DATE 29 FEB 2012



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1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DATUM C IS THE SEATING PLANE.

MILLIMETERS		
DIM	MIN	MAX
A	---	1.45
A1	0.00	0.15
A2	0.90	1.30
b	0.20	0.50
c	0.08	0.26
D	2.70	3.00
E	2.50	3.10
E1	1.30	1.80
e	0.95 BSC	
L	0.20	0.60
L2	0.25 BSC	

**GENERIC MARKING DIAGRAM\***


XXX = Specific Device Code  
M = Date Code  
▪ = Pb-Free Package

(Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present.

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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